





RoHS Compliant

■ Features

- Kyocera's series of Multilayer Ceramic Chip Capacitors are designed to meet a wide variety of needs. We offer a complete range of products for both general and specialized applications.
- We have a network worldwide in order to supply our global customer bases quickly and efficiently and to maintain our reputation as one of the highest-volume producers in the industry
- •All our products are highly reliable due to their monolithic structure of high-purity and superfine uniform ceramics and their integral internal electrodes.
- By combining superior manufacturing technology and materials with high dielectric constants, we produce extremely compact components with exceptional specifications.
- Our stringent quality control in every phase of production from material procurement to shipping ensures consistent manufacturing and super quality.
- Kyocera components are available in a wide choice of dimensions, temperature characteristics, rated voltages, and terminations to meet specific configurational requirements.

■KYOCERA PART NUMBER

CM 03 X5R 225 M 06 A H ____

4 5 6 7 8 OPTION:
Above digits

Above digits are used to track individual ** **Brackaging specification or thickness.

 ①Series
 : CM Series(General)

 ②Size
 : 0201

 ③Dielectric
 : X5R

 ④Capacitance
 : 2.2µF

(a) Capacitance : 2.2µF
(b) Tolerance : ±20%
(c) Voltage : 6.3Vdc
(c) Termination : Sn

\$ Packaging : Cavity pitch 2mm / Reel Size ϕ 180

1) SERIES CODE

CODE	Туре
CM	General
CT	Low Profile
CU	High-Q
KNH	Three Terminal Capacitors

2SIZE CODE

CODE	EIA	JIS	
02	01005	0402	
03	0201	0603	
05	0402	1005 1608	
105	0603		
21	0805	2012	
316	1206	3216	
32	1210	3225	

3DIELECTRIC CODE

Τe	Temperature Compensation Type							
CODE	Temperature Range (℃)	ppn	n/°C					
CG	-55 to 125	0	±30					
CH	-55 10 125	U	±60					

- ·All parts of C0G will be marked as "CG" but will conform to the above table.

	High Dielectric Constant Type								
CODE	Temperature Range (℃)	△C max. (%)	Standard Temperature (°C						
X5R	-55 to 85	±15							
X7R	-55 to 125	±15	25						
X7S	-55 10 125	±22							

4 CAPACITANCE CODE

(Example)

Capacitance expressed in pF.
Two significant digits plus number of zeros.
For Values < 10pF, Letter R denotes decimal point,
<1,000pF=1nF, 1,000nF=1µF>

(Example)

CODE	Capacitance
R50	0.5pF
1R0	1pF
100	10pF
101	100pF
102	1nF
103	10nF
104	100nF
105	1µF
106	10µF

E STANDARD NUMBER							
E3	E6	E12	E24				
	1.0	1.0	1.0	1.1			
1.0	1.0	1.2	1.2	1.3			
1.0	1.5	1.5	1.5	1.6			
	1.5	1.8	1.8	2.0			
	3.3	2.2	2.2	2.4			
2.2		2.7	2.7	3.0			
2.2		3.3	3.3	3.6			
		3.9	3.9	4.3			
	4.7	4.7	4.7	5.1			
4.7	4.7	5.6	5.6	6.2			
4.7	6.8	6.8	6.8	7.5			
	0.0	8.2	8.2	9.1			

⑤TOLERANCE CODE

Temperature Compensation Type (C0G)						
CODE	Tolerance					
A [*]	±0.05pF					
В	±0.1pF					
С	±0.25pF ±0.5pF					
D						
G [*]	±2%					
J	±5%					
K	±10%					

[:] Option

6VOLTAGE CODE

CODE	Rated Voltage
04	4Vdc
06	6.3Vdc
10	10Vdc
16	16Vdc
25	25Vdc
35	35Vdc
50	50Vdc
100	100Vdc

7TERMINATION CODE

CODE	Termination							
A Nickel Barrier/ Tin								
: Pleas is nee	e contact us if Au termination ded.							

®PACKAGING CODE

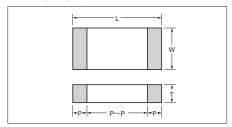
CODE	Size Code	Cavity pitch	Reel size		
Т	105 to 32	4mm			
Н	02 to 05	2mm	φ 180		
Q	03/05	1mm	Ψ 160		
Р	02	1mm			
L	105 to 32	4mm			
N	02 to 05	2mm	Φ330		
W	03/05	1mm			

[:] Option

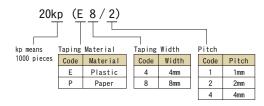


Dimension

■CM/CT/CU Series

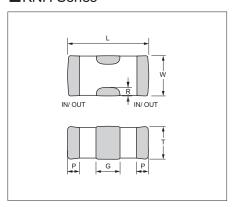


■Packaging Code



0:	Со	de	Dimension			Dimension (mm)				Quantity	per reel
Size	EIA	JIS	Code	L	W	Т	P min.	P max.	P to P min.	φ 180 Reel	φ 330 Reel
02	01005	0402	А	0.4±0.02	0.2±0.02	0.2±0.02	0.07	0.14	0.13	40kp(E4/1) 20kp(P8/2)	- 80kp(P8/2)
			A B	0.6±0.03	0.3±0.03	0.22 max. 0.3±0.03	0.10	0.20	0.20	30kp(P8/1) 15kp(P8/2)	150kp(P8/1) 50kp(P8/2)
03	0201	0603	С	0.6±0.05	0.3±0.05	0.3±0.05	0.13	0.23	0.19	13KP(F0/2)	30KP(F0/2)
			D E	0.6±0.09	0.3±0.09	0.25 max. 0.3±0.09	0.13	0.23	0.19	15kp(P8/2)	_
			A B C	1.0±0.05	0.5±0.05	0.22 max. 0.33 max. 0.5±0.05	0.15	0.35	0.30	20kp(P8/1) 10kp(P8/2)	100kp(P8/1) 50kp(P8/2)
05	0402	.02 1005	D	1.0±0.15	0.5±0.15	0.5±0.15	0.15	0.35	0.30	10kp(P8/2)	50kp (P8/2)
			E	Е	1.0±0.20	0.5±0.20	0.33 max. 0.5±0.20	0.15	0.35	0.30	10kp(P8/2)
405			A B	1.6±0.10	0.8±0.10	0.55 max. 0.8±0.10		0.00	0.50	41 (70(4)	10kp(P8/4)
105	0603	1608	С	1.6±0.15	0.8±0.15	0.8±0.15	0.20	0.60	0.50	4kp(P8/4)	
			D	1.6±0.20	0.8±0.20	0.8±0.20	-				
			Α	2.0±0.10	1.25±0.10	0.95 max.				4kp(P8/4)	10kp(P8/4)
			В	2.0 ± 0.10	1.25 ± 0.10	1.25±0.10				3kp(E8/4)	10kp(E8/4)
21	0805	2012	С	2.0±0.15	1.25±0.15	0.95 max.	0.20	0.75	0.70	4kp(P8/4)	10kp(P8/4)
21	0000	2012	D	2.0 ± 0.15	1.25 ± 0.15	1.25±0.15	0.20	0.75	0.70	3kp(E8/4)	10kp(E8/4)
			Е	2.0±0.20	1.25±0.20	0.95 max.				4kp(P8/4)	10kp(P8/4)
			F	2.0 - 0.20		1.25±0.20				3kp(E8/4)	10kp(E8/4)
			А	3.2±0.20	1.6±0.15	1.6±0.15	0.30	0.85	1.40	2.5kp(E8/4)	5kp(E8/4)
316	1206	3216	В		1.6±0.20	1.6±0.20					OKP (E0/4)
			С	3.2±0.30	1.6±0.30	1.6±0.30	0.30	0.85	1.90	2kp(E8/4)	_
32	1210	3225	Α	3.2 ± 0.30	2.5 ± 0.20	2.5±0.20	0.30	1.00	1.40	1kp(E8/4)	4kp(E8/4)

■KNH Series



Siz	7.0	Co	de	Dimension			Packaging										
312	2e	EIA	JIS	Code	L	W	Т	G	Р	R	φ 180 Reel	φ 330 Reel					
KN		0402	0402 10	0402 1	0402				Α	1.0 ± 0.10	0.5 ± 0.20	0.5max.					
05						1005	В	1.0 ± 0.15	0.5 ± 0.15	0.5 ± 0.15	0.3 ± 0.10	0.15 ± 0.10	≥ 0.05	10kp(P8/2)	_		
0.				С	1.0 ± 0.20	0.5 ± 0.20	0.5 ± 0.20										



General

CM Series

[RoHS Compliant Products]

■ Features

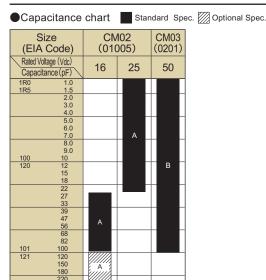
We offer a diverse product line ranging from ultra-compact (0.4 \times 0.2mm) to large (3.2 \times 2.5mm) components configured for a variety of temperature characteristics, rated voltages, and packages. We offer the choice and flexibility for almost any applications.

■ Applications

This standard type is ideal for use in a wide range of applications, from commercial to industrial equipment.

Temperature Compensation Dielectric

Part Number List: P18



<Standard Capacitor Value : E12 Series>

Please contact for capacitance value other than standard.

Alphabets in capacitance chart denote dimensions. Please refer to the below table for detail.

(Example) In case of "B" for CM03; L : 0.6 ± 0.03 mm, W : 0.3 ± 0.03 mm T : 0.3 ± 0.03 mm

		_	imension (mr	m)		Packaging																				
Size	Dimension	U	imension (mi	11)			φ 180 Reel					φ 330 Reel														
Size	Code	1	W	_	Code	Ou contitu	Taping	Taping	Cavity	Code	Ouantit.	Taping	Taping	Cavity												
		L	VV	1	Code	Quantity	Material	Width	Pitch	Code	Quantity	Material	Width	Pitch												
02	Α	0.4 ± 0.00	0.0 ± 0.00	0 0 + 0 00	Р	40,000	Plastic	4mm	1mm	_	_	_	_	_												
02	^	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	Н	20,000	Paper	8mm	2mm	N	80,000	Paper	8mm	2mm
03	В	0.6 ± 0.03	0.2 ± 0.02	0.2 ± 0.02	Q	30,000	Paper	8mm	1mm	W	150,000	Paper	8mm	1mm												
03	Ь	0.6 ± 0.03	0.3 ± 0.03	$3 \pm 0.03 \mid 0.3 \pm 0.03 \mid$	Н	15,000	Paper	8mm	2mm	N	50,000	Paper	8mm	2mm												



General CM Series

【RoHS Compliant Products】

Part Number List: P19-20 X5R Dielectric

● Capacitance chart ■ Standard Spec. Ø Optional Spec.

(EIA	Size A Code)		CM02 (01005))			CM03 (0201)					CN (04	105 02)				CM105 (0603)	
Capac	/oltage (Vdc) citance(pF)	6.3	10	16	4	6.3	10	16	25	4	6.3	10	16	25	35	10	16	25
101	100																	
151	150 220																	
	330																	
	470																	
	680																	
102	1000			A8														
152	1500 2200																	
	3300																	
	4700								В3									
400	6800								D3									
103 153	10000 15000						V//////											
153	22000																	
	33000	A8																
	47000	Ao					B7											
104	68000 100000		Z A8 Z											C3				
104	220000	1/11/1/	∠ A0 2										C8	C3				
	470000	A8				B8 Z C8 Z						C8 2 C7 2						
105	1000000					C8 2		E10				C7 2	C7 2	C7 2	C7 2			C8
	2200000 4700000				E 50 71	C8/E82	E E9 万					C8 Z F8 Z	C8 7 F8 7	PZ F0 Z4		C0	B8	P/ D0 /
106	1000000				E8 ∑						F8 2	₩ F8 2	K 18 7	F8 2		C8		D8 2
-700	15000000									D8 //	F8 2 D8 2							7 20 //
	22000000									F8 2								

Size (EIA Code)		CN (08	Л21 305)		CM316 (1206)						CM32 (1210)				
Rated Voltage (Vdc) Capacitance (pF)	10	16	25	50	6.3	10	16	25	50	100	6.3	10	16	25	50
105 1000000		l	B3	B8											
2200000 4700000 106 10000000	B4	B3 D8 F8	F8			A4	A3	A3 B8	Ø B3 Ø	B3 2			A3	A3 A8	A3
22000000 47000000					B5		B8				A5	A4	A3	A8	

<Standard Capacitance Value>

Please contact for capacitance value other than standard.

Two digits alphanumerics in capacitance chart denote dimensions and tan δ . Please refer to the above table for detail.

(Example) In case of "B3" for CM03 ; L : 0.6 \pm 0.03mm, W : 0.3 \pm 0.03mm, T : 0.3 \pm 0.03mm, Tan δ : 5.0% max.

Code	Tan δ						
3	5.0%max.						
4	7.0%max.						
5	7.5%max.						
7	10.0%max.						
8	12.5%max.						
9	15.0%max.						
10	20.0%max.						

Tan &

		D	Dimension (mm)			Packaging											
Size	Dimension		imension (mi	· · · · · · · · · · · · · · · · · · ·			φ 180 Reel					φ 330 Reel					
Size	Code	L	W	Т	Code	Quantity	Taping Material	Taping Width	Cavity Pitch	Code	Quantity	Taping Material	Taping Width	Cavity Pitch			
02	_	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	Р	40,000	Plastic	4mm	1mm	_	_	_	_	_			
02	A	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	Н	20,000	Paper	8mm	2mm	N	80,000	Paper	8mm	2mm			
	В	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	Q	30,000	Paper	8mm	1mm	W	150,000	Paper	8mm	1mm			
	B	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	Н	15,000	Paper	8mm	2mm	N	50,000	Paper	8mm	2mm			
03	С	0.6 ± 0.05	0.3 ± 0.05	0.3 ± 0.05	Q	30,000	Paper	8mm	1mm	W	150,000	Paper	8mm	1mm			
		0.6 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	Н	15,000	Paper	8mm	2mm	N	50,000	Paper	8mm	2mm			
	Е	0.6 ± 0.09	0.3 ± 0.09	0.3 ± 0.09	Н	15,000	Paper	8mm	2mm	_	_	_	_	_			
	С	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	Q	20,000	Paper	8mm	1mm	W	100,000	Paper	8mm	1mm			
05		1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	Н	10,000	Paper	8mm	2mm	N	50,000	Paper	8mm	2mm			
05	D	1.0 ± 0.15	0.5 ± 0.15	0.5 ± 0.15	Н	10,000	Paper	8mm	2mm	N	50,000	Paper	8mm	2mm			
	F	1.0 ± 0.20	0.5 ± 0.20	0.5 ± 0.20	Н	10,000	Paper	8mm	2mm	_	_	_	_	_			
	В	1.6 ± 0.10	0.8 ± 0.10	0.8 ± 0.10	T	4,000	Paper	8mm	4mm	L	10,000	Paper	8mm	4mm			
105	С	1.6 ± 0.15	0.8 ± 0.15	0.8 ± 0.15	T	4,000	Paper	8mm	4mm	L	10,000	Paper	8mm	4mm			
	D	1.6 ± 0.20	0.8 ± 0.20	0.8 ± 0.20	Т	4,000	Paper	8mm	4mm	L	10,000	Paper	8mm	4mm			
	В	2.0 ± 0.10	1.25 ± 0.10	1.25 ± 0.10	T	3,000	Plastic	8mm	4mm	L	10,000	Plastic	8mm	4mm			
21	D	2.0 ± 0.15	1.25 ± 0.15	1.25 ± 0.15	Т	3,000	Plastic	8mm	4mm	L	10,000	Plastic	8mm	4mm			
	F	2.0 ± 0.20	1.25 ± 0.20	1.25 ± 0.20	T	3,000	Plastic	8mm	4mm	L	10,000	Plastic	8mm	4mm			
316	А	3.2 ± 0.20	1.6 ± 0.15	1.6 ± 0.15	Т	2,500	Plastic	8mm	4mm	L	5,000	Plastic	8mm	4mm			
310	В	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	Т	2,500	Plastic	8mm	4mm	L	5,000	Plastic	8mm	4mm			
32	А	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	Т	1,000	Plastic	8mm	4mm	L	4,000	Plastic	8mm	4mm			

[.] Cpacitance value of less than $0.1 \,\mu$ F :E6 Series

Cpacitance value of $0.1\,\mu\,\mathrm{F}$ and larger :E3 Series



General

CM Series

【RoHS Compliant Products】

X7R Dielectric Part Number List: P19-20

●Capacitance chart ■ Standard Spec. Ø Optional Spec.

Size (EIA Co		CM02 (01005)	CM03 (0201)	CM05 (0402)		CM105 (0603)			CM21 (0805)						
Rated Voltage Capacitance	(pF)	16	10	25	6.3	10	16	6.3	10	16	25	50			
101 151	100 150 220 330														
102 152	470 680 1000 1500	A8													
152	2200 3300 4700		В3												
153	6800 10000 15000		B3												
:	22000 33000 47000 68000														
104 1 2 4	00000 20000 70000			C8					D 0		Do.				
22 47	00000 00000 00000 00000				C8	B8	B8	F8	B3	∑ F8 ∑	B8 F8	€ F3 🖔			

Size (EIA Code)			CM316 (1206)	CM32 (1210)					
Rated Voltage(Vdc) Capacitance(pF)	6.3	10	16	25	50	16	25	50	
2200000 470000 106 1000000 2200000	B8	E B5 7	B8	B8 // B3 //	∑ B3 ∑	A2 A8	A8	A3	

<Standard Capacitance Value>

Capacitance value of less than 0.1 μ F: E6 Series Capacitance value of 0.1 μ F and larger : E3 Series

Please contact for capacitance value other than standard.

Two digits alphanumerics in capacitance chart denote dimensions and tan δ . Please refer to the above table for detail.

Code	Tan δ
2	3.5%max.
3	5.0%max.
5	7.5%max.
8	12.5%max.

(Example)	In case of	"B3"	for CM03	;			
L: 0.6±0	.03mm, W	: 0.3=	±0.03mm,	Т	$: 0.3 \pm 0.03$ mm,	$Tan\delta$: 5.0% max

			imension (mr	n)					Pack	aging				
Size	Dimension		iiileiisioii (iiii	'')			φ 180 Reel					φ 330 Reel		
Size	Code	L	W	Т	Code	Quantity	Taping Material	Taping Width	Cavity Pitch	Code	Quantity	Taping Material	Taping Width	Cavity Pitch
02	Α	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	Р	40,000	Plastic	4mm	1mm	_	_	-	_	_
02	^	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	Н	20,000	Paper	8mm	2mm	N	80,000	Paper	8mm	2mm
03	В	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	Q	30,000	Paper	8mm	1mm	W	150,000	Paper	8mm	1mm
03		0.0 ± 0.03	0.5 ± 0.05	0.5 ± 0.05	Н	15,000	Paper	8mm	2mm	N	50,000	Paper	8mm	2mm
05	С	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	Q	20,000	Paper	8mm	1mm	W	100,000	Paper	8mm	1mm
05		1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	Н	10,000	Paper	8mm	2mm	N	50,000	Paper	8mm	2mm
105	В	1.6 ± 0.10	0.8 ± 0.10	0.8 ± 0.10	Т	4,000	Paper	8mm	4mm	L	10,000	Paper	8mm	4mm
105	С	1.6 ± 0.15	0.8 ± 0.15	0.8 ± 0.15	Т	4,000	Paper	8mm	4mm	L	10,000	Paper	8mm	4mm
21	В	2.0 ± 0.10	1.25 ± 0.10	1.25 ± 0.10	Т	3,000	Plastic	8mm	4mm	L	10,000	Plastic	8mm	4mm
21	F	2.0 ± 0.20	1.25 ± 0.20	1.25 ± 0.20	Т	3,000	Plastic	8mm	4mm	L	10,000	Plastic	8mm	4mm
316	В	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	Т	2,500	Plastic	8mm	4mm	L	5,000	Plastic	8mm	4mm
32	Α	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T	1,000	Plastic	8mm	4mm	L	4,000	Plastic	8mm	4mm

X7S Dielectric

Part Number List: P20

	Size (Code)	CM316 (1206)
	Voltage(Vdc) citance(pF)	100
105	1000000	
106	2200000 4700000 10000000	Ø B3 Ø Ø C3 Ø

Two digits alphanumerics in capacitance chart denote dimensions and tan $\,\delta$. Please refer to the above table for detail.

(Example) In case of "B3" for CM316 ; L : 3.2 \pm 0.20mm, W : 1.6 \pm 0.20mm, T : 1.6 \pm 0.20mm, Tan δ : 5.0% max.

Tan δ Code	Tan δ
3	5.0%max.

	Dimension Code	Dimension (mm)					Packaging									
Size		J	imension (mi	11)	φ 180 Reel				φ 330 Reel							
Size		L	W	Т	Code	Quantity	Taping Material	Taping Width	Cavity Pitch	Code	Quantity	Taping Material	Taping Width	Cavity Pitch		
316	В	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	Т	2,500	Plastic	8mm	4mm	L	5,000	Plastic	8mm	4mm		
310	С	3.2 ± 0.30	1.6 ± 0.30	1.6 ± 0.30	Т	2,000	Plastic	8mm	4mm	_	_	_	_	_		



Test Conditions and Standards

Test Conditions and Specifications for Temperature Compensation Type (C Δ Characteristics) CM / CU Series

Test Items		Test Conditions	Specifications		
Capacitance V	alue (C)	Capacitance Frequency Volt	Within tolerance		
Q	<u> </u>	C≤1000pF 1MHz ± 10% C>1000pF 1kHz ± 10% C>1000pF 1kHz ± 10%	C≥30pF: Q≥1000 C<30pF: Q≥400+20C		
Insulation Resistance (IR)		Measured after the rated voltage is applied for 1 minute at room ambient. The charge and discharge current of the capacitor must not exceed 50mA.	Over $10000M\Omega$ or $500M\Omega$ • μF , whichever is less		
Dielectric Resi	stance	Apply 3 times of the rated voltage for 1 to 5 seconds. The charge and discharge current of the capacitor must not exceed 50mA.	No problem observed		
Appearance		Microscope	No problem observed		
Termination St	rength	Apply a sideward force of 500g (5N) to a PCB-mounted sample. Apply 2N for 0201, and 1N for 01005 size.	No problem observed		
Bending Streng	gth	Glass epoxy PCB: Fulcrum spacing: 90mm, duration time 10 seconds.	No significant damage at 1mm bent		
Vibration	Appearance	Vibration frequency: 10 to 55 (Hz)	No problem observed		
Test	ΔC	Amplitude: 1.5mm Sweeping condition: 10 → 55 → 10Hz/ 1 minute	Within Tolerance		
	Q	in X, Y and Z Directions: 2 hours each, 6 hours total.	C≥30pF : Q≥1000 C<30pF : Q≥400+20C		
Soldering	Appearance	Soak the sample in 260°C ± 5°C solder for 10	No problem observed		
Heat Resistance	ΔC	\pm 0.5 seconds and place in room ambient, and measure after 24 \pm 2 hours.	Within ± 2.5% or ± 0.25pF, whichever is larger		
	Q	(Pre-heating conditions) Order Temperature Time	C≥30pF : Q≥1000 C<30pF : Q≥400+20C		
	IR	1 80 to 100°C 2 minutes	Over $10000M\Omega$ or $500M\Omega \cdot \mu F$ whichever is less		
	Withstanding Voltage	2 150 to 200°C 2 minutes The charge and discharge current of the capacitor must not exceed 50mA for IR and withstanding voltage measurement.	Resist without problem		
Solderablity		Snaking condition $3 \pm 0.5 \text{ sec.}$ Sn-3Ag-0.5Cu $245 \pm 5^{\circ}$ C $3 \pm 0.5 \text{ sec.}$ Sn63 Solder $235 \pm 5^{\circ}$ C $2 \pm 0.5 \text{ sec.}$	Solder coverage : 90% min.		
Temperature	Appearance	(Cycle)	No problem observed		
Cycle	ΔC	Room temperature (3min.) →	Within ± 2.5% or ± 0.25pF, whichever is larger		
	Q	Lowest operation temperature (30min.) →	C≥30pF : Q≥1000		
		Room temperature (3min.) → Highest operation temperature(30min.)	C<30pF : Q≥400+20C		
	IR		Over $10000M\Omega$ or $500M\Omega \cdot \mu F$, whichever is less		
	Withstanding Voltage	After 5 cycles, measure after 24 \pm 2 hours. The charge and discharge current of the capacitor must not exceed 50mA for IR and withstanding voltage measurement.	Resist without problem		
Load	Appearance	After applying rated voltage for 500+12/ - 0	No problem observed		
Humidity Test	ΔC	hours in pre-condition at 40℃ ± 2℃ , humidity 90 to 95%RH, allow parts to stabilize for 24 ±	Within \pm 7.5% or \pm 0.75pF, whichever is larger		
	Q	2 hours, at room temperature before measurement.	C≥30pF : Q≥200 C<30pF : Q≥100+10C/ 3		
	IR	The charge and discharge current of the capacitor must not exceed 50mA for IR measurement.	Over $500M\Omega$ or $25M\Omega$ · μF , whichever is less		
High-	Appearance	After applying twice the rated voltage at the	No problem observed.		
Temperature with Loading	ΔC	temperature of 125 \pm 3°C for 1000+12/ – 0	Within \pm 3% or \pm 0.3pF, whichever is larger		
	Q	hours, measure the sample after 24 \pm 2 hours. The charge and discharge current of the capacitor must not exceed 50mA for IR	C≥30pF: Q≥350 10pF <c<30pf: 2<br="" q≥275+5c="">C<10pF: Q≥200+10C</c<30pf:>		
	IR	measurement.	Over $1000M\Omega$ or $50M\Omega \cdot \mu F$, whichever is less		

Please ask for individual specification for the hatched range in previous chart.



Test Conditions and Standards

Test Conditions and Specifications for High Dielectric Type (X5R, X7R) CM / CT Series

Test	Items	Test Conditions	Specifications		
Capacitance V	alue (C)	Measure after heat treatment	Within tolerance		
Tan δ		Capacitance Frequency Volt C≤10µF 1kHz ± 10% 1.0 ± 0.2Vrms C>10µF 120Hz ± 10% 0.5 ± 0.2Vrms	Refer to capacitance chart		
Insulation Res	istance (IR)	Measured after the rated voltage is applied for 1 minute at room ambient. The charge and discharge current of the capacitor must not exceed 50mA.	Over $10000M\Omega$ or $500M\Omega$ • μF , whichever is less		
Dielectric Resi	stance	Apply 2.5 times of the rated voltage for 1 to 5 seconds. The charge and discharge current of the capacitor must not exceed 50mA.	No problem observed		
Appearance		Microscope	No problem observed		
Termination St	rength	Apply a sideward force of 500g (5N) to a PCB-mounted sample. note: 2N for 0201 size, and 1N for 01005 size. Exclude CT series with thickness of less than 0.66mm.	No problem observed		
Bending Stren	gth	Glass epoxy PCB: Fulcrum spacing: 90mm, duration time 10 seconds. Exclude CT series with thickness of less than 0.66mm.	No significant damage at 1mm bent		
Vibration Test	Appearance	Take the initial value after heat treatment. Vibration frequency: 10 to 55 (Hz)	No problem observed		
	ΔC	Amplitude: 1.5mm Sweeping condition: 10 → 55 → 10Hz/1 minute in X, Y and Z	Within tolerance		
	Tan δ	Directions: 2 hours each, 6 hours total, and place in room ambient, and measure the sample after heat treatment.	Within tolerance		
Soldering Heat	Appearance	Take the initial value after heat treatment. Soak the sample in 260 $^{\circ}$ C \pm 5 $^{\circ}$ C solder for 10	No problem observed		
Resistance	ΔC	± 0.5 seconds and place in room ambient, and measure after heat treatment.	Within ± 7.5%		
	Tan δ	(Pre-heating conditions)	Within tolerance		
	IR	Order Temperature Time 1 80 to 100°C 2 minutes	Over $10000M\Omega$ or $500M\Omega$ · μF , whichever is less		
	Withstanding Voltage	2 150 to 200°C 2 minutes The charge and discharge current of the capacitor must not exceed 50mA for IR and withstanding voltage measurement.	Resist without problem		
Solderablity			Solder coverage : 90% min.		
Temperature	Appearance	Take the initial value after heat treatment.	No problem observed		
Cycle	ΔC	(Cycle) Room temperature (3min.) →	Within ± 7.5%		
	Tan δ	Lowest operation temperature (30min.) →	Within tolerance		
	Withstanding Voltage	Room temperature (3min.) → Highest operation temperature(30min.) After 5 cycles, measure after heat treatment. The charge and discharge current of the capacitor must not exceed 50mA for IR and withstanding voltage measurement.	Over $10000M\Omega$ or $500M\Omega$ • μF , whichever is less Resist without problem		
Load Humidity	Appearance	Take the initial value after heat treatment. After applying rated voltage for 500+12/ – 0	No problem observed		
Test	ΔC	hours in pre-condition at 40°C ± 2°C , humidity	Within ± 12.5%		
	Tan δ	90 to 95%RH, and place in room ambient, and measure the sample after heat treatment.	200% max. of initial value		
	IR	The charge and discharge current of the capacitor must not exceed 50mA for IR measurement.	Over $500M\Omega$ or $25M\Omega \cdot \mu F$, whichever is less		
High- Temperature	Appearance	Take the initial value after heat treatment. After applying twice the rated voltage at the	No problem observed		
with Loading	ΔC	highest operation temperature for 1000+12/ – 0 hours, measure the sample after heat treatment.	Within ± 12.5%		
	Tan δ	The charge and discharge current of the capacitor must not exceed 50mA for IR measurement.	200% max. of initial value		
	IR	Apply 1.5 times when the rated voltage is 10V or less. Applied voltages for respective products are indicated in the below chart.	Over $1000M\Omega$ or $50M\Omega \cdot \mu F$, whichever is less		

Heat treatment Keep specimen at 150+0/ - 10℃ for 1 hour, leave specimen at room ambient for 24 ± 2 hours.

High-temperature with Loading Applied Voltage (Rated Voltage imes \Box)

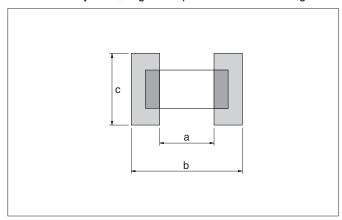
	ing. it compositions with a second of the control o									
Applied Voltage	Rated Voltage	Products								
× 1.3	6.3V	CM02X5R153-104, CM105X5R475, CT03X5R104								
	16V	CM02X5R101-103, CM05X5R224, CM105X5R225, CM21X5R475-106, CM316X5R226, CM02X7R101-222,								
	160	CM105X7R105, CM316X7R106, CM32X7R226, CT105X5R105, CT21X5R475								
× 1.5	25V	CM03X5R332-103, CM105X5R105, CM21X5R225-475, CM316X5R106, CM32X5R106-226,								
	230	CM05X7R104, CM21X7R105-225, CM316X7R475, CM32X7R106								
	50V	CM21X5R105, CM32X5R106, CM32X7R106, CT21X5R225								

Please ask for individual specification for the hatched range in previous chart.



Test Conditions and Standards

Substrate for Adhesion Strength Test, Vibration Test, Soldering Heat Resistance Test, Temperature Cycle Test, Load Humidity Test, High-Temperature with Loading Test.

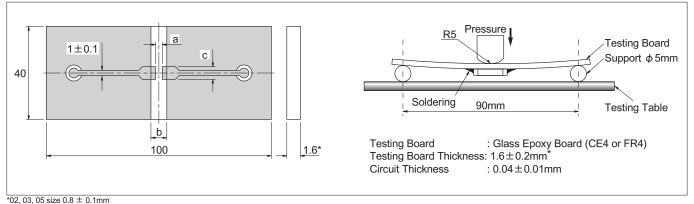


Size (EIA Code)	а	b	С
02 (01005)	0.15	0.50	0.20
03 (0201)	0.26	0.92	0.32
05 (0402)	0.4	1.4	0.5
105 (0603)	1.0	3.0	1.2
21 (0805)	1.2	4.0	1.65
316 (1206)	2.2	5.0	2.0
32 (1210)	2.2	5.0	2.9

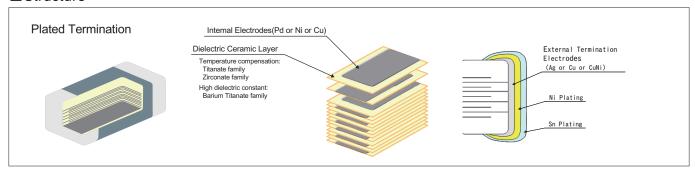
Substrate for Bending Test

(Unit: mm)

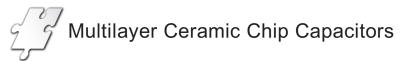
(Unit: mm)



■Structure



- $\cdot \ \mathsf{Please} \ \mathsf{contact} \ \mathsf{your} \ \mathsf{local} \ \mathsf{Kyocera} \ \mathsf{sales} \ \mathsf{office} \ \mathsf{or} \ \mathsf{distributor} \ \mathsf{for} \ \mathsf{specifications} \ \mathsf{not} \ \mathsf{covered} \ \mathsf{in} \ \mathsf{this} \ \mathsf{catalog}.$
- Our products are continually being improved. As a result, the capacitance range of each series is subject to change without notice. Please contact sales representative to confirm compatibility with your application.





Packaging Options Tape and Reel

Reel

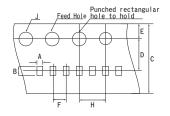


-	W2	-
E C	W ₁	B
→	1	•

Code Reel	А	В	С	D	
7-inch Reel (CODE: T, H, Q)	180 +0				
7-inch Reel (CODE: P)	178±2.0	φ 60 min.	13±0.5	21±0.8	
13-inch Reel (CODE: L, N, W)	330±2.0				
Code Reel	E	W1	W2	R	
7-inch Reel (CODE: T, H, Q)		10.5±1.5	16.5 max.		
7-inch Reel (CODE: P)	2.0±0.5	4.35±0.3	6.95±1.0	1.0	
13-inch Reel (CODE: L, N, W)		9.5±1.0	9.5±1.0 16.5 max.		

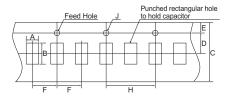
Carrier Tape

F=1mm (02 Size)



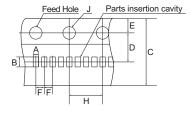


F=2mm (02, 03, 05 Size)



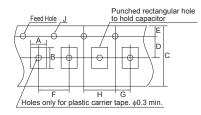


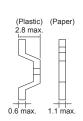
F=1mm (02, 03, 05 Size)





F=4mm (105, 21, 316, 32 Size)





Carrier Tape

(Unit: mm)

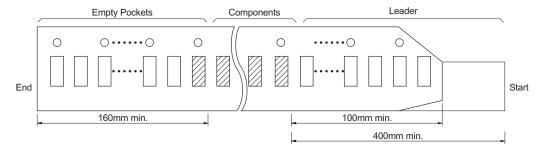
Carrier Tapo											
Size	Α	В	С	C D E F G H	Н	J	Carrier Tape				
(EIA Code)	/ \				_					Width	Material
02 (01005)*	0.23 ± 0.02	0.43 ± 0.02	4.0 ± 0.08	1.8±0.02	0.9±0.05	1.0 ± 0.02	_	2.0 ± 0.04	0.8 ± 0.04	4mm	Plastic
02 (01003)	0.25 ± 0.03	0.45 ± 0.03	8.0 ± 0.3	3.5±0.05	1.75±0.1	2.0 ± 0.05	_	4.0 ± 0.1	1.5+0.1/-0	8mm	Paper
03 (0201)*	0.27 ± 0.02	0.67±0.03	8.0+0.3/-0.1	3.5±0.05	1.75±0.1	1.0±0.05	_	4.0 ± 0.05	1.5+0.1/-0	8mm	Paper
03 (0201)	0.37 ± 0.03	0.07 ± 0.03	8.0 ± 0.3	3.5 ± 0.05	1.75 ± 0.1	2.0 ± 0.05] _	4.0 ± 0.1	1.5+0.1/-0	OHIIII	гарег
	0.65 + 0.1	0.65±0.1 1.15±0.1	8.0+0.3/-0.1		1.75±0.1	1.0±0.05	_	4.0 ± 0.05			
05 (0402)*	0.05 ± 0.1		8.0±0.3	3.5 ± 0.05		2.0±0.05	_	4.0±0.1	1.5+0.1/-0	8mm	Paper
	0.75±0.1		0.0 ± 0.3			2.0 ± 0.05	_	4.0 ± 0.1			
105 (0603)	1.0±0.2	1.8±0.2	8.0 ± 0.3	3.5 ± 0.05	1.75±0.1	4.0 ± 0.1	2.0 ± 0.05	4.0 ± 0.1	1.5+0.1/-0	8mm	Paper
21 (0805)	1.5±0.2	2.3±0.2	8.0±0.3	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	4.0±0.1	1.5+0.1/-0	8mm	Paper
21 (0003)	1.5 ± 0.2	2.3 ± 0.2	0.0 ± 0.3	3.5 ± 0.05	1.75±0.1	4.0 ± 0.1	2.0 ± 0.05			8mm	Plastic
246 (4206)	2.0±0.2	26+02 00+0	0.2 8.0±0.3 3.5	3.5±0.05	1.75±0.1	4.0±0.1	2.0±0.05	05 4.0±0.1	1.5+0.1/-0	8mm	Paper
316 (1206)	2.0 ± 0.2	3.6 ± 0.2	0.0 ± 0.3	3.5 ± 0.05	1.75±0.1	4.0 ± 0.1	2.0 ± 0.05	4.0 ± 0.1	1.5+0.1/-0	8mm	Plastic
32 (1210)	2.9 ± 0.2	3.6 ± 0.2	8.0 ± 0.3	3.5 ± 0.05	1.75±0.1	4.0±0.1	2.0 ± 0.05	4.0 ± 0.1	1.5+0.1/-0	8mm	Plastic

^{*} Option



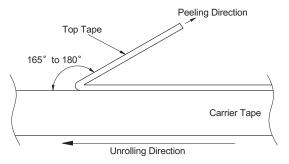
Packaging Options

Detail of leader and trailer



Adhesive tape

- 1) The exfoliative strength when peeling off the top tape from the carrier tape by the method of the following figure shall be '0.1 to 0.7N. '02 Size: 0.1 to 0.5N
- 2) When the top tape is peeled off, the adhesive stays on the top tape.
- 3) Chip capacitors will be in a state free without being stuck on the thermal adhesive tape.



Exfoliating angle: 165 to 180 degrees to the carrier tape. Exfoliating speed: 300 mm/min.

Carrier tape

- 1) Chip will not fall off from carrier tape or carrier tape will not be damaged by bending than within a radius of 25mm.
- 2) The chip are inserted continuously without any empty pocket.
- 3) Chip will not be mis-mounted because of too big clearance between components and cavity. Also the waste of carrier tape will not fill a nozzle hole of mounting machine.

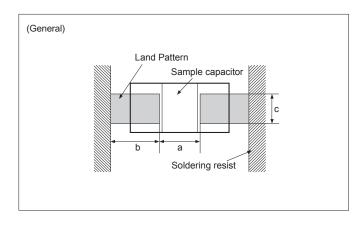


Surface Mounting Information

Dimensions for recommended typical land

Since the amount of solder (size of fillet) to be used has direct influence on the capacitor after mounting, the sufficient consideration is necessary.

When the amounts of solder is too much, the stress that a capacitor receives becomes larger. It may become the cause of a crack in the capacitor. When the land design of printed wiring board is considered, it is necessary to set up the form and size of land pattern so that the amount of solder is suitable.



General

(Unit: mm)

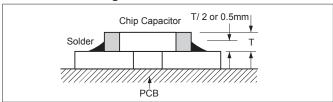
Size	Dime	nsion	Recommended land dimensions					
(EIA Code)	L	W/T	а	b	С			
02 (01005)	0.4 ± 0.02	0.2 ± 0.02	0.13 to 0.20	0.12 to 0.18	0.20 to 0.23			
	0.6 ± 0.03	0.3 ± 0.03	0.20 to 0.25	0.25 to 0.35	0.30 to 0.40			
03 (0201)	0.6 ± 0.05	0.3 ± 0.05	0.20 to 0.25	0.20 10 0.33	0.50 to 0.40			
03 (0201)	0.6 ± 0.09	0.3 ± 0.09	U 33 to U 30	0.25 to 0.35	0.30 to 0.45			
	0.6 ± 0.10	0.3 ± 0.10	0.23 10 0.30	0.23 10 0.33	0.30 10 0.43			
	1.0 ± 0.05	0.5 ± 0.05	0.30 to 0.50	0.35 to 0.45	0.40 to 0.60			
	1.0 ± 0.07	0.5 ± 0.07	0.30 to 0.50 0.35 to 0.45	0.40 to 0.00				
05 (0402)	1.0 ± 0.10	0.5 ± 0.10	0.30 to 0.50	0.40 to 0.50	0.50 to 0.75			
03 (0402)	1.0 ± 0.10	0.5 ± 0.20	0.30 10 0.30	0.40 10 0.30	0.30 to 0.73			
	1.0 ± 0.15	0.5 ± 0.15	0.40 to 0.60	0.40 to 0.50	0.50 to 0.75			
	1.0 ± 0.20	0.5 ± 0.20	0.40 10 0.00	0.40 10 0.30	0.30 to 0.73			
	1.6 ± 0.10	0.8 ± 0.10	0.70 to 1.00	0.80 to 1.00	0.60 to 0.90			
105 (0603)	1.6 ± 0.15	0.8 ± 0.15	0 80 to 1 00	0.80 to 1.00	0 90 to 1 10			
	1.6 ± 0.20	0.8 ± 0.20	0.80 to 1.00	0.80 10 1.00	0.80 to 1.10			
	2.0 ± 0.10	1.25 ± 0.10	1.00 to 1.30	1.00 to 1.20	1.00 to 1.45			
21 (0805)	2.0 ± 0.15	1.25 ± 0.15	1 00 to 1 30	1.00 to 1.20	1 25 to 1 55			
	2.0 ± 0.20	1.25 ± 0.20	1.00 to 1.30	1.00 to 1.20	1.23 10 1.33			
	3.2 ± 0.20	1.6 ± 0.15	2.10 to 2.50	1.10 to 1.30	1.40 to 1.90			
316 (1206)	3.2 ± 0.20	1.6 ± 0.20	2 10 to 2 50	1.10 to 1.30	1 60 to 2 00			
	3.2 ± 0.30	1.6 ± 0.30	2.10 10 2.30	1.10 10 1.30	1.00 10 2.00			
32 (1210)	3.2 ± 0.30	2.5 ± 0.20	2.10 to 2.50	1.10 to 1.30	1.90 to 2.80			

^{*} Recommended land dimensions may differ depending on dimensional tolerance.

Design of printed circuit and Soldering

The recommended fillet height shall be 1/2 of the thickness of capacitors or 0.5mm. When mounting two or more capacitors in the common land, it is necessary to separate the land with the solder resist strike so that it may become the exclusive land of each capacitor.

Ideal Solder Height



Item	Not recommended example	Recommended example/ Separated by solder
Multiple parts mount		Solder resist
Mount with leaded parts	Leaded parts	Solder resist Leaded parts
Wire soldering after mounting	Soldering iron Wire	Solder resist
Overview	Solder resist	Solder resist

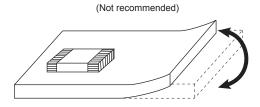


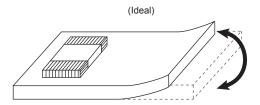
Surface Mounting Information

Mounting Design

The chip could crack if the PCB warps during processing after the chip has been soldered.

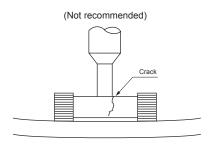
Recommended chip position on PCB to minimize stress from PCB warpage

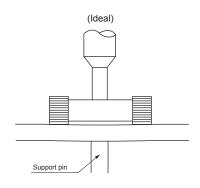




Actual Mounting

- 1) If the position of the vacuum nozzle is too low, a large force may be applied to the chip capacitor during mounting, resulting in cracking.
- 2) During mounting, set the nozzle pressure to a static load of 1 to 3 N.
- 3) To minimize the shock of the vaccum nozzle, provide a support pin on the back of the PCB to minimize PCB flexture.





4) Bottom position of pick up nozzle should be adjusted to the top surface of a substrate which camber is corrected.

Resin Mold

- 1) If a large amount of resin is used for molding the chip, cracks may occur due to contraction stress during curing. To avoid such cracks, use a low shrinkage resin.
- 2) The insulation resistance of the chip will degrade due to moisture absorption. Use a low moisture absorption resin.
- 3) Check carefully that the resin does not generate a decomposition gas or reaction gas during the curing process or during normal storage. Such gases may crack the chip capacitor or damage the device itself.



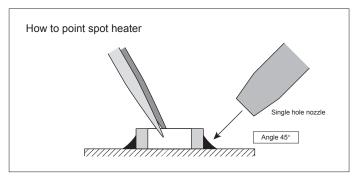
Surface Mounting Information

Soldering Method

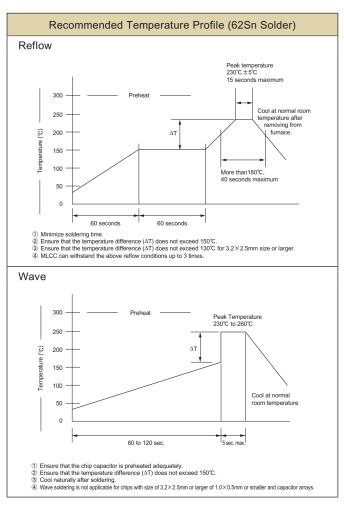
- 1) Ceramic is easily damaged by rapid heating or cooling. If some heat shock is unavoidable, preheat enough to limit the temperature difference (Delta T) to within 150 degree Celsius.
- 2) The product size 1.6 \times 0.8mm to 3.2 \times 1.6mm can be used in reflow and wave soldering, and the product size of bigger than 3.2 \times 1.6mm, or smaller than 1.6 \times 0.8mm can be used in reflow.
 - Circuit shortage and smoking can be created by using capacitors which are used neglecting the above caution.
- 3) Please see our recommended soldering conditions.
- 4) In case of using Sn-Zn Solder, please contact us in advance.
- 5) The following condition is recommended for spot heater application.

Recommended spot heater condition

Item	Condition			
Distance	5mm min.			
Angle	45°			
Projection Temp.	400°C max.			
Flow rate	Set at the minimum			
Nozzle diameter	2 φ to 4 φ (Single hole type)			
Application time	10 sec. max. (1206 and smaller) 30 sec.max. (1210 and larger)			



Recommended Temperature Profile (Sn-3Ag-0.5Cu) Reflow 250°C ± 10°C 5 to 10 sec. max 300 ပ္စ 200 170 to 180℃ 150 100 90±30 sec. Minimize soldering time. Ensure that allowable temperature difference does not exceed 150°C. Ensure that allowable temperature difference does not exceed 130°C for 3.2×2.5mm size or larger Ensure that allowable temperature difference does not exceed MLCC can withstand the above reflow conditions up to 3 times. Wave 300 Peak Temperatu 245°C to 260°C 250 3 200 ٥ 60 to 120 sec



Soldering iron

1) Temperature of iron chip

1206 and smaller 350°C max. 5) Cautions

1210 and larger 280°C max. 80W max.

- 2) Wattage
- 3) Tip shape of soldering iron ϕ 3.0mm max.
- 4) Soldering Time
- 3 sec. max.

① Ensure that the chip capacitor is preheated adequately.
② Ensure that the temperature difference (ΔT) does not exceed 150°C.
③ Cool naturally after soldering.
④ Wave soldering is not applicable for chips with size of 3.2×2.5mm or larger of 1.0×0.5mm or smaller and capacitor arrays.

- a) Pre-heating is necessary rapid heating must be avoided. Delta T≤150°C (product size of bigger than 3.2 × 1.6mm. Delta T≤130°C)
- b) Avoid direct touching to capacitors.
- c) Avoid rapid cooling after soldering. Natural cooling is recommended.

*Consult as if it is difficult to keep the temperature 280°C max. for 1210 and larger MLCC'S.



Precautions

Circuit Design

- 1. Once application and assembly environments have been checked, the capacitor may be used in conformance with the rating and performance which are provided in both the catalog and the specifications. Use exceeding that which is specified may result in inferior performance or cause a short, open, smoking, or flaming to occur, etc.
- 2. Please consult the manufacturer in advance when the capacitor is used in devices such as: devices which deal with human life, i.e. medical devices; devices which are highly public orientated; and devices which demand a high standard of liability.
 Accident or malfunction of devices such as medical devices, space equipment and devices having to do with atomic power could generate grave consequence with respect to human lives or, possibly, a portion of the public. Capacitors used in these devices may require high reliability design different from that of general purpose capacitors.
- 3. Please use the capacitors in conformance with the operating temperature provided in both the catalog and the specifications.

 Be especially cautious not to exceed the maximum temperature. In the situation the maximum temperature set forth in both the catalog and specifications is exceeded, the capacitor's insulation resistance may deteriorate, power may suddenly surge and short-circuit may occur. The capacitor has a loss, and may self-heat due to equivalent series resistance when alternating electric current is passed therethrough. As this effect becomes especially pronounced in high frequency circuits, please exercise caution.

 When using the capacitor in a (self-heating) circuit, please make sure the surface of the capacitor remains under the maximum temperature for usage. Also, please make certain temperature rises remain below 20°C.
- 4. Please keep voltage under the rated voltage which is applied to the capacitor. Also, please make certain the peak voltage remains below the rated voltage when AC voltage is super-imposed to the DC voltage.
 In the situation where AC or pulse voltage is employed, ensure average peak voltage does not exceed the rated voltage.
 Exceeding the rated voltage provided in both catalog and specifications may lead to defective withstanding voltage or, in worst case situations, may cause the capacitor to smoke or flame.
- 5. When the capacitor is to be employed in a circuit in which there is continuous application of a high frequency voltage or a steep pulse voltage, even though it is within the rated voltage, please inquire to the manufacturer.
 In the situation the capacitor is to be employed using a high frequency AC voltage or a extremely fast rising pulse voltage, even though it is within the rated voltage, it is possible capacitor reliability will deteriorate.
- 6. It is a common phenomenon of high-dielectric products to have a deteriorated amount of static electricity due to the application of DC voltage.

 Due caution is necessary as the degree of deterioration varies depending on the quality of capacitor materials, capacity, as well as the load voltage at the time of operation.
- 7. Do not use the capacitor in an environment where it might easily exceed the respective provisions concerning shock and vibration specified in the catalog and specifications.
 In addition, it is a common piezo phenomenon of high dielectric products to have some voltage due to vibration or to have noise due to voltage change. Please contact sales in such case.
- 8. If the electrostatic capacity value of the delivered capacitor is within the specified tolerance, please consider this when designing the respective product in order that the assembled product function appropriately.
- 9. Please contact us upon using conductive adhesives.

Storage

- 1. If the component is stored in minimal packaging (a heat-sealed or zippered plastic bag), the bag should be kept closed. Once the bag has been opened, reseal it or store it in a desiccator.
- 2. Keep storage place temperature + 5 to + 40 degree C, humidity 20 to 70% RH. See JIS C 60721-3-1, class 1K2 for other climatic conditions
- 3. The storage atmosphere must be free of corrosive gas such as sulfur dioxide and chlorine. Also, avoid exposing the product to saline moisture. If the product is exposed to such atmospheres, the terminals will oxidize and solderability will be effected.
- 4. Precautions 1) to 3) apply to chip capacitors packaged in carrier tapes.
- 5. The solderability is assured for 6 months from our shipping date if the above storage precautions are followed.

Safety application guideline and detailed information of electrical properties are also provided in Kyocera web site; URL: https://global.kyocera.com/prdct/electro/





General CM02 Series Size (JIS Code): 01005(0402) # Packaging Code (Packaging quantity): H(20,000pcs.) / N(80,000pcs.) / P(40,000pcs.)

Dielectric code	Canacitanaa	apacitance :Tolerance	Voltage	Part Number	Q		# Packaging Code		
СФ	Сараспапсе		[V]	Part Number	Q	L[mm]	W[mm]	T[mm]	(quantity)
	1pF			CM02C ∆ 1R0 □ 25A#	420	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	1.5pF	B: ± 0.1pF / C: ± 0.25pF		CM02C ∆ 1R5 □ 25A#	430	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	2pF		25	CM02C ∆ 2R0 □ 25A#	440	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	3pF	В. ⊥ 0.1рг / С. ⊥ 0.25рг	25	CM02C ∆ 3R0 □ 25A#	460	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	4pF			CM02C ∆ 4R0 □ 25A#	480	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	5pF			CM02C ∆ 5R0 □ 25A#	500	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	6pF			CM02C ∆ 6R0 □ 25A#	520	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	7pF	C: ± 0.25pF / D: ± 0.5pF	25	CM02C ∆ 7R0 □ 25A#	540	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	8pF	C: ± 0.25pF / D: ± 0.5pF	25	CM02C ∆ 8R0 □ 25A#	560	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	9pF			CM02C ∆ 9R0 □ 25A#	580	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	10pF		25	CM02C △ 100 □ 25A#	600	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	12pF			CM02C △ 120 □ 25A#	640	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	15pF	J: ± 5% / K: ± 10%		CM02C ∆ 150 □ 25A#	700	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
CG/CH	18pF			CM02C ∆ 180 □ 25A#	760	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	22pF			CM02C ∆ 220 □ 25A#	840	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	27pF			CM02C △ 270 □ 16A#	940	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	33pF			CM02C ∆ 330 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	39pF			CM02C ∆ 390 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	47pF			CM02C △ 470 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	56pF			CM02C △ 560 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	68pF	I. I. 50/ /I/: I. 400/	40	CM02C ∆ 680 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	82pF	J: ± 5% / K: ± 10%	16	CM02C ∆ 820 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	100pF			CM02C ∆ 101 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	120pF			CM02C ∆ 121 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	150pF			CM02C ∆ 151 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	180pF			CM02C ∆ 181 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	220pF			CM02C ∆ 221 □ 16A#	1000	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P

General CM03 Series Size (JIS Code): 0201(0603) # Packaging Code (Packaging quantity): H(15,000pcs.) / N(50,000pcs.) / Q(30,000pcs.) / W(150,000pcs.)

Dielectric code	Capacitance	□:Tolerance	Voltage [V]	Part Number	Q		Dimension		# Packaging Code
CΔ	Capacitance			T art Number	_ ~	L[mm]	W[mm]	T[mm]	(quantity)
	1pF			CM03C ∆ 1R0 □ 50A#	420	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	1.5pF			CM03C ∆ 1R5 □ 50A#	430	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	2pF	D: + 0.1°F / C: + 0.25°F	50	CM03C ∆ 2R0 □ 50A#	440	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	3pF	B: $\pm 0.1pF / C$: $\pm 0.25pF$	50	CM03C ∆ 3R0 □ 50A#	460	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	4pF			CM03C ∆ 4R0 □ 50A#	480	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	5pF			CM03C ∆ 5R0 □ 50A#	500	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	6pF	C: ± 0.25pF / D: ± 0.5pF	50	CM03C ∆ 6R0 □ 50A#	520	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	7pF			CM03C ∆ 7R0 □ 50A#	540	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	8pF			CM03C ∆ 8R0 □ 50A#	560	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	9pF			CM03C ∆ 9R0 □ 50A#	580	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	10pF			CM03C ∆ 100 □ 50A#	600	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
CG/CH	12pF			CM03C ∆ 120 □ 50A#	640	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	15pF			CM03C ∆ 150 □ 50A#	700	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	18pF			CM03C ∆ 180 □ 50A#	760	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	22pF			CM03C ∆ 220 □ 50A#	840	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	27pF			CM03C ∆ 270 □ 50A#	940	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	33pF	J: ± 5% / K: ± 10%	50	CM03C ∆ 330 □ 50A#	1000	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	39pF			CM03C △ 390 □ 50A#	1000	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	47pF			CM03C ∆ 470 □ 50A#	1000	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	56pF			CM03C ∆ 560 □ 50A#	1000	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	68pF			CM03C ∆ 680 □ 50A#	1000	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	82pF			CM03C ∆ 820 □ 50A#	1000	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	100pF			CM03C ∆ 101 □ 50A#	1000	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W





General CM02 Series Size (JIS Code): 01005(0402) # Packaging Code (Packaging quantity): H(20,000pcs.) / N(80,000pcs.) / P(40,000pcs.)

Dielectric code	Capacitance	□:Tolerance	Voltage	Part Number	Tan δ		Dimension		# Packaging Code
Dielectric code	Capacitance	□.Tolerance	[V]		[%]	L[mm]	W[mm]	T[mm]	(quantity)
	100pF			CM02X5R101 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	150pF			CM02X5R151 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	220pF			CM02X5R221 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	330pF			CM02X5R331 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	470pF			CM02X5R471 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	680pF			CM02X5R681 ☐ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	1nF	$K: \pm 10\% / M: \pm 20\%$	16	CM02X5R102 ☐ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	1.5nF			CM02X5R152 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	2.2nF			CM02X5R222 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	3.3nF			CM02X5R332 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
X5R	4.7nF			CM02X5R472 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
XSK	6.8nF			CM02X5R682 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	10nF			CM02X5R103 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	15nF	K: ± 10% / M: ± 20%		CM02X5R153 □ 06A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	22nF			CM02X5R223 □ 06A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	33nF		6.3	CM02X5R333 □ 06A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	47nF			CM02X5R473 □ 06A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	68nF			CM02X5R683 □ 06A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	400-5	14 1 100/ /11 1 000/	10	CM02X5R104 □ 10A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	100nF	$K: \pm 10\% / M: \pm 20\%$	6.3	CM02X5R104 □ 06A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	220nF	M4: 1 000/	0.0	CM02X5R224M06A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	470nF	M: ± 20%	6.3	CM02X5R474M06A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	100pF			CM02X7R101 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	150pF			CM02X7R151 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	220pF			CM02X7R221 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	330pF	K: ± 10% / M: ± 20%		CM02X7R331 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
X7R	470pF		16	CM02X7R471 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	680pF			CM02X7R681 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	1nF			CM02X7R102 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	1.5nF			CM02X7R152 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P
	2.2nF		1	CM02X7R222 □ 16A#	12.5	0.4 ± 0.02	0.2 ± 0.02	0.2 ± 0.02	H/N/P

General CM03 Series Size (JIS Code): 0201(0603) # Packaging Code (Packaging quantity): H(15,000pcs.) / N(50,000pcs.) / Q(30,000pcs.) / W(150,000pcs.)

Dielectric code	Capacitance	□:Tolerance	Voltage	Part Number	Tan δ			# Packaging Code	
Diciocino code	Capacitance		[V]		[%]	L[mm]	W[mm]	T[mm]	(quantity)
	3.3nF			CM03X5R332 □ 25A#	5.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	4.7nF	K: ± 10% / M: ± 20%	25	CM03X5R472 □ 25A#	5.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	6.8nF	K. ± 10/6 / Wi. ± 20/6	25	CM03X5R682 □ 25A#	5.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	10nF			CM03X5R103 □ 25A#	5.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	15nF			CM03X5R153 □ 10A#	10.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	22nF	K: ± 10% / M: ± 20%		CM03X5R223 □ 10A#	10.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	33nF		10	CM03X5R333 □ 10A#	10.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	47nF			CM03X5R473 □ 10A#	10.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
X5R	68nF			CM03X5R683 □ 10A#	10.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
AJIX	100nF			CM03X5R104 □ 10A#	10.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	220nF			CM03X5R224 □ 10A#	10.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	470nF	K: ± 10% / M: ± 20%	6.3	CM03X5R474 □ 06A#	12.5	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	1µF	M: ± 20%	16	CM03X5R105M16AH	20.0	0.6 ± 0.09	0.3 ± 0.09	0.3 ± 0.09	Н
	ιμι		6.3	CM03X5R105M06A#	12.5	0.6 ± 0.05	0.3 ± 0.05	0.3 ± 0.05	H/N/Q/W
			10	CM03X5R225M10AH	15.0	0.6 ± 0.09	0.3 ± 0.09	0.3 ± 0.09	Н
	2.2µF	M: ± 20%	6.3	CM03X5R225M06AH	12.5	0.6 ± 0.09	0.3 ± 0.09	0.3 ± 0.09	Н
			0.5	CM03X5R225M06A#035	12.5	0.6 ± 0.05	0.3 ± 0.05	0.3 ± 0.05	H/N/Q/W
	4.7µF	M: ± 20%	4	CM03X5R475M04AH	12.5	0.6 ± 0.09	0.3 ± 0.09	0.3 ± 0.09	Н
	3.3nF			CM03X7R332 □ 10A#	5.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
X7R	4.7nF	K: ± 10% / M: ± 20%	10	CM03X7R472 □ 10A#	5.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
ATIX	6.8nF	13. ± 10/0 / IVI. ± 20/0	10	CM03X7R682 □ 10A#	5.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W
	10nF			CM03X7R103 □ 10A#	5.0	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	H/N/Q/W

General CM05 Series Size (JIS Code): 0402(1005) # Packaging Code (Packaging quantity): H(10,000pcs.) / N(50,000pcs.) / Q(20,000pcs.) / W(100,000pcs.)

Dielectric code	Canacitanas	□:Tolerance	Voltage	Part Number	Tan δ		# Packaging Code		
Dielectric code	Capacitance		[V]	Part Number	[%]	L[mm]	W[mm]	T[mm]	(quantity)
	100nF	K: ± 10% / M: ± 20%	25	CM05X5R104 ☐ 25A#	5.0	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	H/N/Q/W
	220nF	K: ± 10% / M: ± 20%	16	CM05X5R224 ☐ 16A#	12.5	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	H/N/Q/W
	470nF	K: ± 10% / M: ± 20%	10	CM05X5R474 □ 10A#	12.5	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	H/N/Q/W
	1µF		35	CM05X5R105 ☐ 35A#	10.0	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	H/N/Q/W
		K: ± 10% / M: ± 20%	25	CM05X5R105 □ 25A#	10.0	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	H/N/Q/W
			16	CM05X5R105 ☐ 16A#	10.0	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	H/N/Q/W
			10	CM05X5R105 ☐ 10A#	10.0	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	H/N/Q/W
X5R	2.2µF	K: ± 10% / M: ± 20%	16	CM05X5R225 ☐ 16A#	12.5	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	H/N/Q/W
NOIN			10	CM05X5R225 □ 10A#	12.5	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	H/N/Q/W
		M: ± 20%	25	CM05X5R475M25AH	12.5	1.0 ± 0.20	0.5 ± 0.20	0.5 ± 0.20	Н
	4.7µF		16	CM05X5R475M16AH	12.5	1.0 ± 0.20	0.5 ± 0.20	0.5 ± 0.20	H
			10	CM05X5R475M10AH	12.5	1.0 ± 0.20	0.5 ± 0.20	0.5 ± 0.20	H
	10µF	M: ± 20%	6.3	CM05X5R106M06AH	12.5	1.0 ± 0.20	0.5 ± 0.20	0.5 ± 0.20	H
	15µF	M: ± 20%	6.3	CM05X5R156M06A#	12.5	1.0 ± 0.15	0.5 ± 0.15	0.5 ± 0.15	H/N
			4	CM05X5R156M04A#	12.5	1.0 ± 0.15	0.5 ± 0.15	0.5 ± 0.15	H/N
	22µF	M: ± 20%	4	CM05X5R226M04AH	12.5	1.0 ± 0.20	0.5 ± 0.20	0.5 ± 0.20	Н
X7R	100nF	K: ± 10% / M: ± 20%	25	CM05X7R104 ☐ 25A#	12.5	1.0 ± 0.05	0.5 ± 0.05	0.5 ± 0.05	H/N/Q/W





General CM105 Series Size (JIS Code): 0603(1608) # Packaging Code (Packaging quantity): T(4,000pcs.) / L(10,000pcs.)

Dielectric code		□:Tolerance	Voltage [V]	Part Number	Tan δ		# Packaging Code		
Dielectric code	Capacitance				[%]	L[mm]	W[mm]	T[mm]	(quantity)
	1µF	K: ± 10% / M: ± 20%	25	CM105X5R105 □ 25A#	12.5	1.6 ± 0.15	0.8 ± 0.15	0.8 ± 0.15	T/L
	2.2µF	K: ± 10% / M: ± 20%	16	CM105X5R225 □ 16A#	12.5	1.6 ± 0.10	0.8 ± 0.10	0.8 ± 0.10	T/L
X5R	4.7µF	K: ± 10% / M: ± 20%	25	CM105X5R475 □ 25A#	12.5	1.6 ± 0.20	0.8 ± 0.20	0.8 ± 0.20	T/L
			10	CM105X5R475 □ 10A#	12.5	1.6 ± 0.15	0.8 ± 0.15	0.8 ± 0.15	T/L
	10µF	K: ± 10% / M: ± 20%	25	CM105X5R106 □ 25A#	15.0	1.6 ± 0.20	0.8 ± 0.20	0.8 ± 0.20	T/L
	1µF	K: ± 10% / M: ± 20%	16	CM105X7R105 ☐ 16A#	12.5	1.6 ± 0.10	0.8 ± 0.10	0.8 ± 0.10	T/L
X7R		N. ⊥ 10% / WI. ± 20%	10	CM105X7R105 □ 10A#	12.5	1.6 ± 0.10	0.8 ± 0.10	0.8 ± 0.10	T/L
	2.2µF	K: ± 10% / M: ± 20%	6.3	CM105X7R225 □ 06A#	12.5	1.6 ± 0.15	0.8 ± 0.15	0.8 ± 0.15	T/L

General CM21 Series Size (JIS Code): 0805(2012) # Packaging Code (Packaging quantity): T(3,000pcs.) / L(10,000pcs.)

Dielectric code	Capacitance	□:Tolerance	Part Number	Part Number	Tan δ			# Packaging Code	
Dielectric code	Capacitance			[%]	L[mm]	W[mm]	T[mm]	(quantity)	
	1µF	K: ± 10% / M: ± 20%	50	CM21X5R105 □ 50A#	12.5	2.0 ± 0.10	1.25 ± 0.10	1.25 ± 0.10	T/L
	ıμι	K. ± 10% / W. ± 20%	25	CM21X5R105 □ 25A#	5.0	2.0 ± 0.10	1.25 ± 0.10	1.25 ± 0.10	T/L
	2.2µF	K: ± 10% / M: ± 20%	25	CM21X5R225 □ 25A#	12.5	2.0 ± 0.20	1.25 ± 0.20	1.25 ± 0.20	T/L
X5R		K. ± 10%/W. ± 20%	16	CM21X5R225 □ 16A#	5.0	2.0 ± 0.10	1.25 ± 0.10	1.25 ± 0.10	T/L
\ \ASK	4.7µF	K: ± 10% / M: ± 20%	25	CM21X5R475 □ 25A#	12.5	2.0 ± 0.20	1.25 ± 0.20	1.25 ± 0.20	T/L
			16	CM21X5R475 □ 16A#	12.5	2.0 ± 0.15	1.25 ± 0.15	1.25 ± 0.15	T/L
			10	CM21X5R475 □ 10A#	7.0	2.0 ± 0.10	1.25 ± 0.10	1.25 ± 0.10	T/L
	10µF	K: ± 10% / M: ± 20%	16	CM21X5R106 □ 16A#	12.5	2.0 ± 0.20	1.25 ± 0.20	1.25 ± 0.20	T/L
			50	CM21X7R105 □ 50A#	5.0	2.0 ± 0.20	1.25 ± 0.20	1.25 ± 0.20	T/L
	1µF	K: \pm 10% / M: \pm 20%	25	CM21X7R105 □ 25A#	12.5	2.0 ± 0.10	1.25 ± 0.10	1.25 ± 0.10	T/L
X7R			10	CM21X7R105 □ 10A#	5.0	2.0 ± 0.10	1.25 ± 0.10	1.25 ± 0.10	T/L
A/K	2.2µF	K: ± 10% / M: ± 20%	25	CM21X7R225 □ 25A#	12.5	2.0 ± 0.20	1.25 ± 0.20	1.25 ± 0.20	T/L
	4.7µF	K: ± 10% / M: ± 20%	16	CM21X7R475 □ 16A#	12.5	2.0 ± 0.20	1.25 ± 0.20	1.25 ± 0.20	T/L
	10µF	K: ± 10% / M: ± 20%	6.3	CM21X7R106 □ 06A#	12.5	2.0 ± 0.20	1.25 ± 0.20	1.25 ± 0.20	T/L

General CM316 Series Size (JIS Code): 1206(3216) # Packaging Code (Packaging quantity): T(2,500pcs.) / L(5,000pcs.)

Dialostria sada	0:	□:Tolerance	Voltage	Part Number	Tan δ			# Packaging	
Dielectric code	Capacitance		[V]	Part Number	[%]	L[mm]	W[mm]	T[mm]	Code (quantity)
	2.2µF	K. + 100/ /M. + 200/	100	CM316X5R225 ☐ 100A#	5.0	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
	2.2μΓ	K: ± 10% / M: ± 20%	25	CM316X5R225 □ 25A#	5.0	3.2 ± 0.20	1.6 ± 0.15	1.6 ± 0.15	T/L
	4.7µF	K. + 400/ /M. + 200/	50	CM316X5R475 □ 50A#	5.0	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
		K: ± 10% / M: ± 20%	25	CM316X5R475 □ 25A#	5.0	3.2 ± 0.20	1.6 ± 0.15	1.6 ± 0.15	T/L
X5R	10μF	K: ± 10% / M: ± 20%	25	CM316X5R106 □ 25A#	12.5	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
			16	CM316X5R106 ☐ 16A#	5.0	3.2 ± 0.20	1.6 ± 0.15	1.6 ± 0.15	T/L
			10	CM316X5R106 □ 10A#	7.0	3.2 ± 0.20	1.6 ± 0.15	1.6 ± 0.15	T/L
	22µF	K: ± 10% / M: ± 20%	16	CM316X5R226 □ 16A#	12.5	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
			6.3	CM316X5R226 □ 06A#	7.5	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
	4.7	K: ± 10% / M: ± 20%	50	CM316X7R475 ☐ 50A#	5.0	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
	4.7µF		25	CM316X7R475 □ 25A#	12.5	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
VZD	10	K: ± 100/ /M: ± 200/	25	CM316X7R106 ☐ 25A#	5.0	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
X7R	10µF	K: \pm 10% / M: \pm 20%	16	CM316X7R106 ☐ 16A#	12.5	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
	22µF	K: ± 10% / M: ± 20%	10	CM316X7R226 □ 10A#	7.5	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
			6.3	CM316X7R226 □ 06A#	12.5	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L
X7S	2.2µF	K: ± 10% / M: ± 20%	100	CM316X7S225 ☐ 100A#	5.0	3.2 ± 0.20	1.6 ± 0.20	1.6 ± 0.20	T/L

General CM316 Series Size (JIS Code): 1206(3216) # Packaging Code (Packaging quantity): T(2,000pcs.)

Dielectric code	Capacitance	□:Tolerance	Voltage [V]	Part Number	Tan δ [%]	Dimension			# Packaging Code
						L[mm]	W[mm]	T[mm]	(quantity)
X7S	4.7µF	K: ± 10% / M: ± 20%	100	CM316X7S475 ☐ 100AT	5.0	3.2 ± 0.30	1.6 ± 0.30	1.6 ± 0.30	Т

General CM32 Series Size (JIS Code): 1210(3225) # Packaging Code (Packaging quantity): T(1,000pcs.) / L(4,000pcs.)

Dielectric code	Capacitance	□:Tolerance	Voltage	Part Number	Tan δ		# Packaging Code		
Dielectric code	Сараспапсе		[V]	r ait Nullibei	[%]	L[mm]	W[mm]	T[mm]	(quantity)
	4.7µF	K: ± 10% / M: ± 20%	25	CM32X5R475 □ 25A#	5.0	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
	10µF		50	CM32X5R106 □ 50A#	5.0	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
		K: ± 10% / M: ± 20%	25	CM32X5R106 □ 25A#	12.5	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
X5R			16	CM32X5R106 □ 16A#	5.0	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
ASK	22µF	K: ± 10% / M: ± 20%	25	CM32X5R226 □ 25A#	12.5	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
			16	CM32X5R226 □ 16A#	5.0	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
			10	CM32X5R226 □ 10A#	7.0	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
	47µF	K: ± 10% / M: ± 20%	6.3	CM32X5R476 □ 06A#	7.5	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
	4.7µF	K: ± 10% / M: ± 20%	16	CM32X7R475 □ 16A#	2.5	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
X7R	10uF	K: ± 10% / M: ± 20%	50	CM32X7R106 □ 50A#	5.0	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
\ \^/K	Ιυμε	K: ± 10% / WI: ± 20%	25	CM32X7R106 □ 25A#	12.5	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L
	22µF	K: ± 10% / M: ± 20%	16	CM32X7R226 □ 16A#	12.5	3.2 ± 0.30	2.5 ± 0.20	2.5 ± 0.20	T/L



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